



Material Content Data Sheet



Sales Product Name		ITS724G		Issued		27. September 2017			
MA#		MA001368818							
Package		PG-DSO-20-32		Weight*		479.05 mg			
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	9.466	1.98	1.98	19761	19761	
leadframe	inorganic material	phosphorus	7723-14-0	0.036	0.01		75		
	non noble metal	zinc	7440-66-6	0.143	0.03		299		
	non noble metal	iron	7439-89-6	2.862	0.60		5974		
wire	non noble metal	copper	7440-50-8	116.197	24.26	24.90	242556	248904	
	non noble metal	aluminium	7429-90-5	0.418	0.09	0.09	872	872	
	encapsulation	organic material	carbon black	1333-86-4	0.687	0.14		1434	
encapsulation	plastics	epoxy resin	-	31.601	6.60		65967		
	inorganic material	silicondioxide	60676-86-0	311.205	64.94	71.68	649629	717030	
leadfinish	non noble metal	tin	7440-31-5	2.780	0.58	0.58	5804	5804	
plating	noble metal	silver	7440-22-4	1.177	0.25	0.25	2456	2456	
glue	plastics	epoxy resin	-	0.434	0.09		905		
	noble metal	silver	7440-22-4	2.045	0.43	0.52	4268	5173	
*deviation	< 10%				Sum in total:		100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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